

TOSHIBA Diode Silicon Epitaxial Planar Type

# HN2D01F

Ultra High Speed Switching Application

- HN2D01F is composed of 3 independent diodes.
- Low forward voltage :  $V_F(3) = 0.98V$  (typ.)
- Fast reverse recovery time:  $t_{rr} = 1.6ns$  (typ.)
- Small total capacitance :  $C_T = 0.5\mu F$  (typ.)

## Absolute Maximum Ratings (Ta = 25°C)

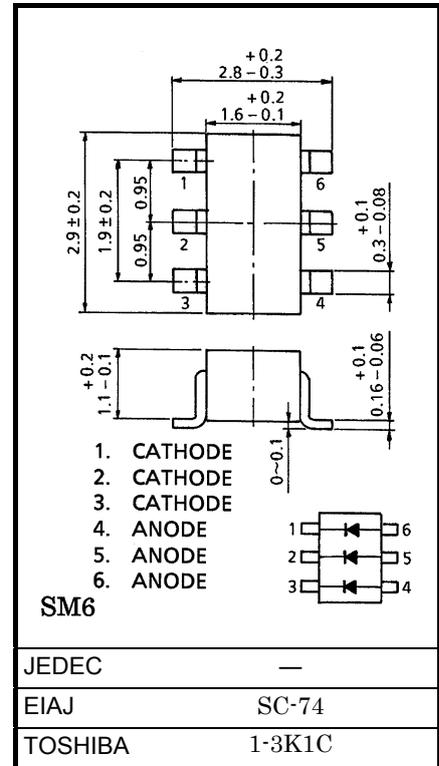
Characteristic	Symbol	Rating	Unit
Maximum (peak) reverse Voltage	$V_{RM}$	85	V
Reverse voltage	$V_R$	80	V
Maximum (peak) forward current	$I_{FM}$	240 (*)	mA
Average forward current	$I_O$	80 (*)	mA
Surge current (10ms)	$I_{FSM}$	1 (*)	A
Power dissipation	P	300	mW
Junction temperature	$T_j$	125	°C
Storage temperature range	$T_{stg}$	-55~125	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- (\*) This is absolute maximum rating of single diode (Q1 or Q2 or Q3).  
 In the case of using 2 or 3 diodes, the absolute maximum ratings per diodes is 75 % of the single diode one.

Unit in mm

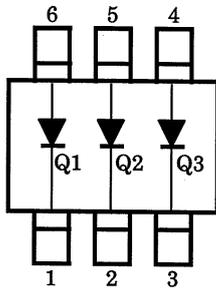


Weight: 0.015g

## Electrical Characteristics (Q1, Q2, Q3 Common Ta = 25°C)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Forward voltage	$V_F(1)$	—	$I_F = 1mA$	—	0.62	—	V
	$V_F(2)$	—	$I_F = 10mA$	—	0.75	—	
	$V_F(3)$	—	$I_F = 100mA$	—	0.98	1.20	
Reverse current	$I_R(1)$	—	$V_R = 30V$	—	—	0.1	$\mu A$
	$I_R(2)$	—	$V_R = 80V$	—	—	0.5	
Total capacitance	$C_T$	—	$V_R = 0, f = 1MHz$	—	0.5	3.0	pF
Reverse recovery time	$t_{rr}$	—	$I_F = 10mA$ (Fig.1)	—	1.6	4.0	ns

### Pin Assignment (Top View)



### Marking

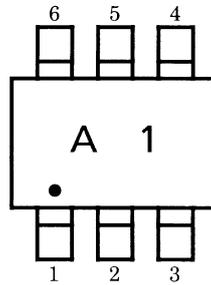
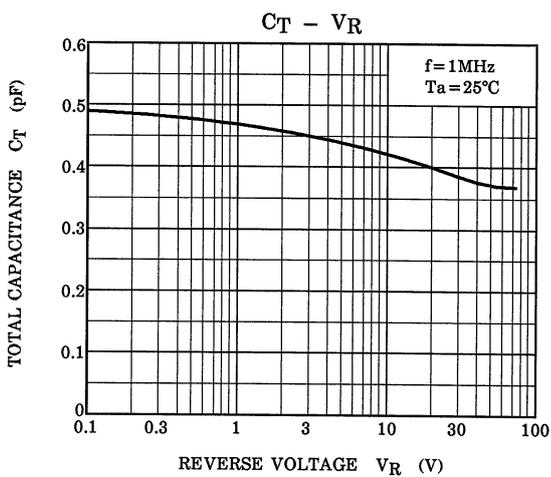
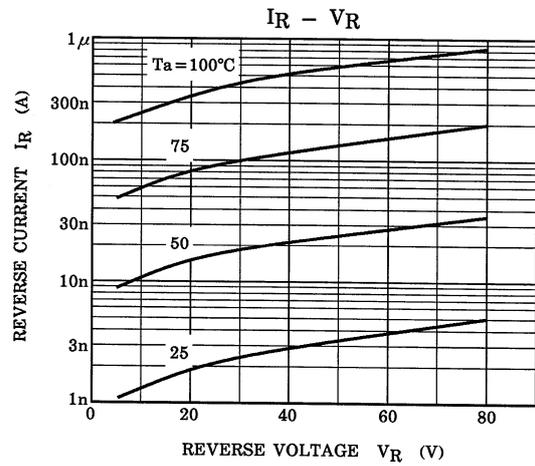
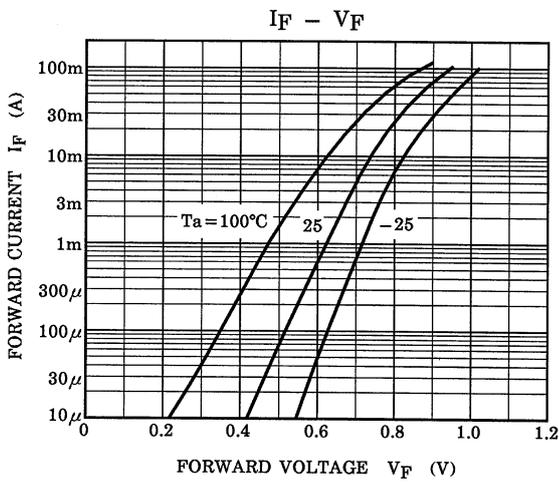
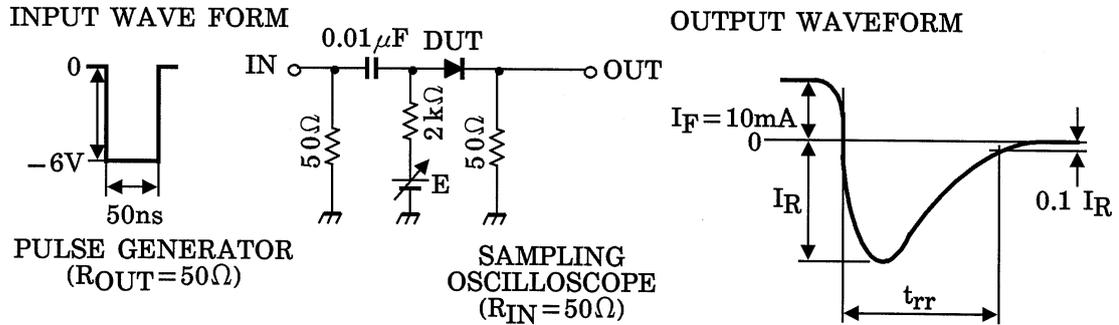


Fig.1 Reverse Recovery Time ( $t_{rr}$ ) Test Circuit



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20070701-EN GENERAL

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- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.  
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